

REV.	SPECIFICATION	ECN NO.	APPD.
X5			

Material and Plating:

Housing: LCP, 30% Glass Filled, UL94V-0, BLACK.

Power Contacts: High Conductivity Copper.

Au(3u")+Pd/Ni (27u") gold plated on Contact Area and 80u" Min Tin Plated on Solder Tail over nickel 50u" Min under plated .

Signal Contact: Phosphor Bronze.

Au(3u")+Pd/Ni (27u") gold plated on Contact Area and 80u" Min Tin Plated on Solder Tail over nickel 50u" Min under plated .

Electrical Characteristics:

Current Rating: Signal Pin 2.5 AMP.

Power Pin 30 AMP.

Dielectric Withstanding Voltage: DC 1000V For 1 minute.

Insulator Resistance: 1000M Ω min.Contact Resistance: Signal Pin 10m Ω max.Power Pin 0.3m Ω max.

Operating Temperature: -40°C ~+105°C .

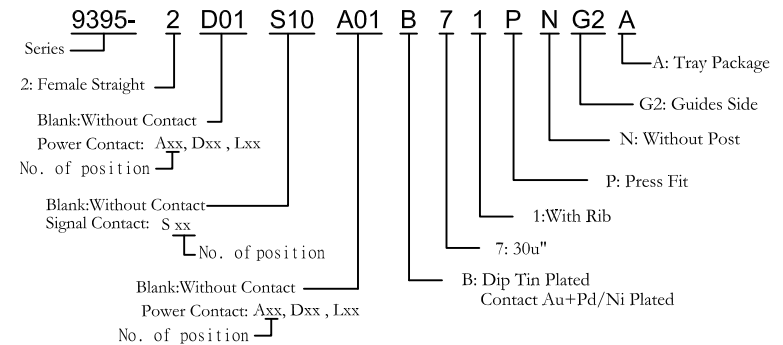
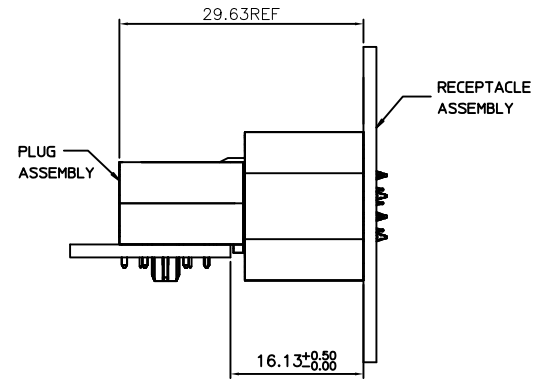
***RoHS Compliant**

Notes :

L: Low Power---PCB Mount 3.0mm Pitch

D: DC Power---PCB Mount 5.5mm Pitch

A: AC Power---PCB Mount 7.5mm Pitch



Tolerances	Dwg. No.	9395-D0000-009		Title: 9395 Series Max P60 10mm Low Profile, 60Amp Receptacle, Straight	OUPIIN OUPIIN ELECTRONIC(KUNSHAN) CO., LTD. P/N:9395-2D01S10A01B71PNG2A			
x = ±0.5	Projection				SHEET	1/1	Ver. No.	X5
.x = ±0.25	Unit	mm	Scale		1:1			
.xx = ±0.15	Drawn By	LQ 07/20'16						